



# Product Change Notification

**Change Notification #:** 118513-00  
**Change Title:** Intel® Server System S9232WK1HLC  
Compute Module,  
PCN 118513-00, Product Design,  
Base Board Resistor Change  
**Date of Publication:** October 19, 2021

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *</b>	November 3, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is updating the resistor values and firmware of the Hot Swap Controller (HSC) on the Intel® Server Compute Modules, Server Chassis and Server Systems listed in the Product Affected table.

The change improves the current sense and prevents a premature trip of the Over Current Protection (OCP) mechanism when Processors reach PMAX during normal operation under heavy HPC workloads.

The change requires the Top Assembly (TA#) numbers and the Printed Board Assembly (PBA) numbers to roll up as shown in the Products Affected table in this document.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System S9232WK1HLC Compute Module, Single	S9232WK1HLC	999D9W	K26072-005	K20718-351	K26072-006	K20718-352

## **PCN Revision History:**

**Date of Revision:**

October 19, 2021

**Revision Number:**

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**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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